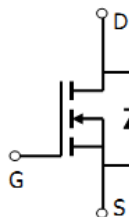
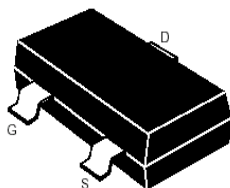


SOT-23

Features

- Advanced trench process technology
- High Density Cell Design For Ultra Low On-Resistance

Maximum Ratings & Thermal Characteristics

(Ratings at 25°C ambient temperature unless otherwise specified.)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V_{DS}	20	V	
Gate-Source Voltage	V_{GS}	± 12		
Continuous Drain Current	I_D	3.6	A	
Pulsed Drain Current ¹⁾	I_{DM}	8		
Maximum Power Dissipation	P_D	TA = 25°C	1.25	W
		TA = 75°C	0.8	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150	°C	
Junction-to-Ambient Thermal Resistance (PCB mounted) ²⁾	$R_{\theta JA}$	78	°C/W	

Notes

- ¹⁾ Pulse width limited by maximum junction temperature.
- ²⁾ Surface Mounted on FR4 Board, $t \leq 5$ sec.

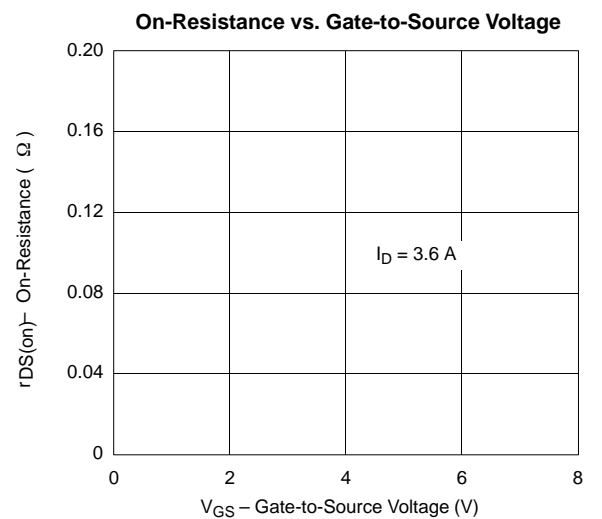
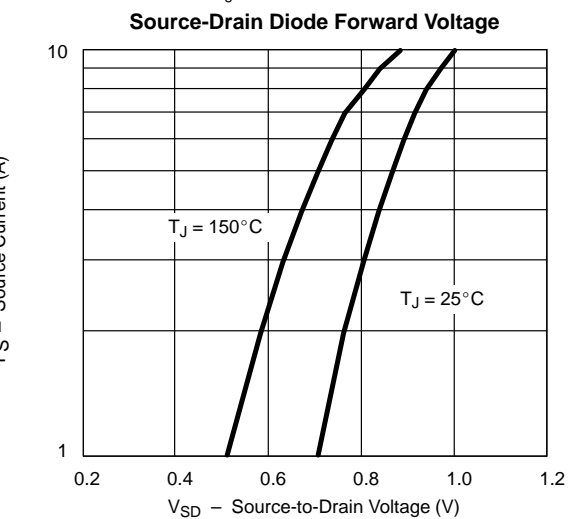
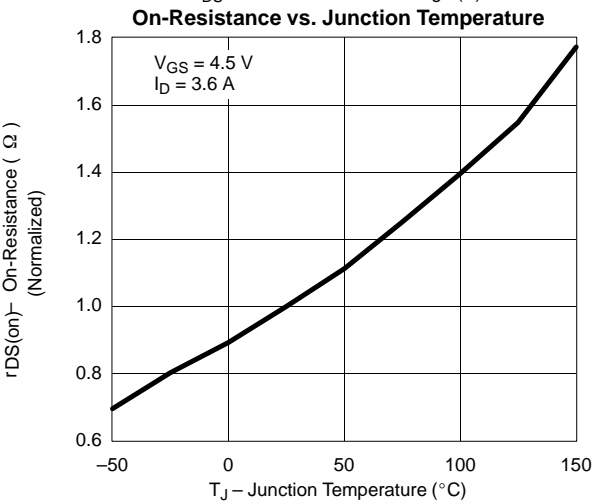
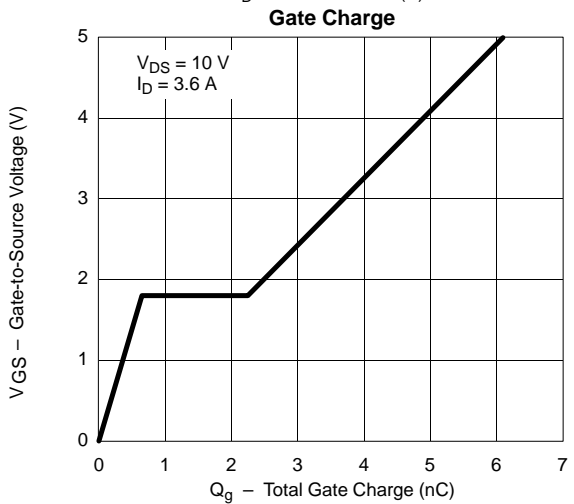
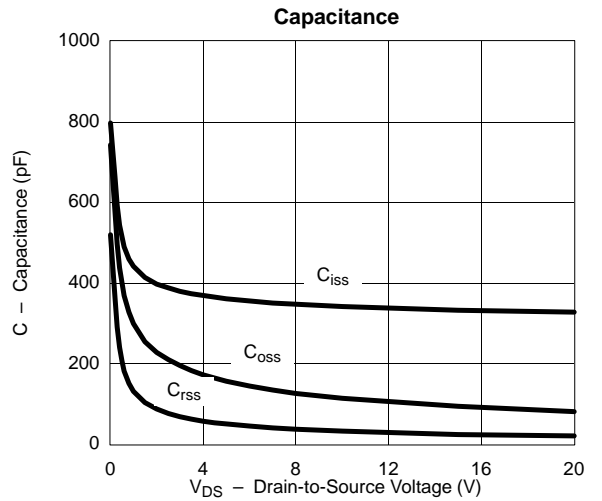
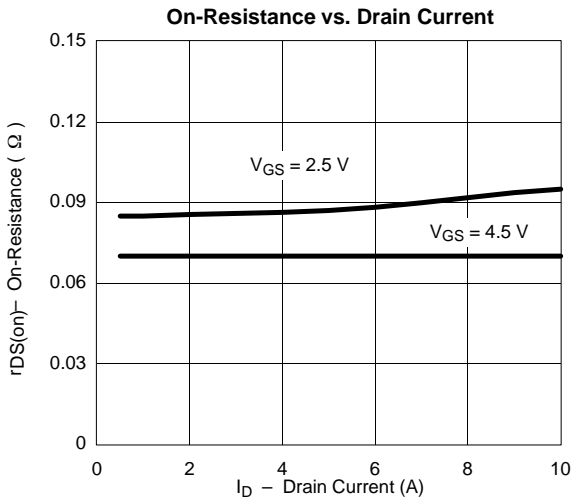
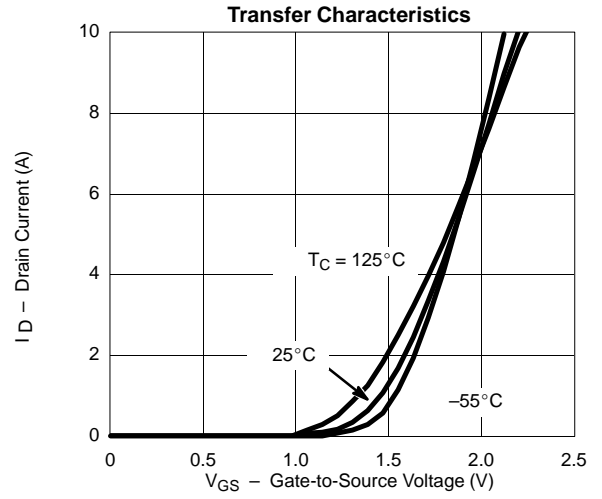
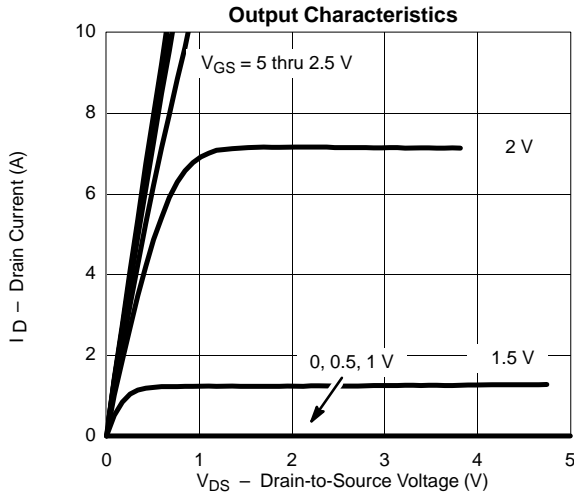
Electrical Characteristics

(Ratings at 25°C ambient temperature unless otherwise specified.)

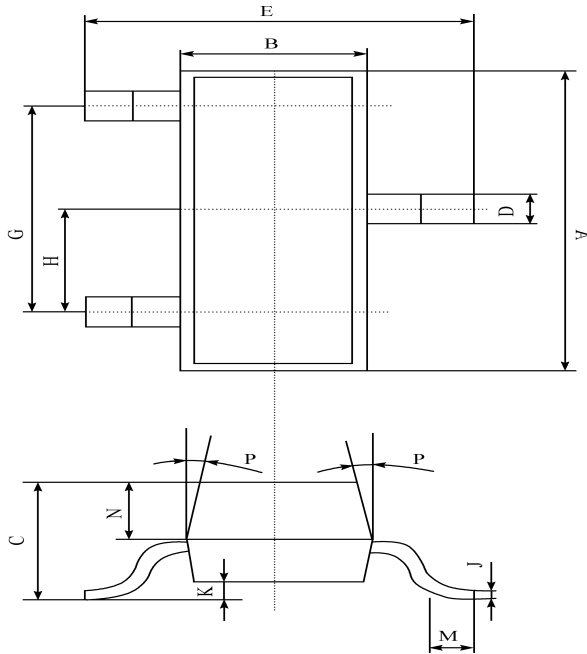
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static ³⁾						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	20			V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 2.5V, I_D = 3.1A$		70.0	80.0	mΩ
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 3.6A$		60.0	70.0	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.6	0.76		V
Zero Gate Voltage Drain Current I_{D0}	I_{DSS}	$V_{DS} = 20V, V_{GS} = 0V$			1	μA
Gate Body Leakage	I_{GSS}	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA
Forward Transconductance	g_{fs}	$V_{DS} = 5V, I_D = 4.2A$		5	—	S
Dynamic ⁴⁾						
Total Gate Charge	Q_g	$V_{DS} = 10V, I_D = 3.6A$ $V_{GS} = 4.5V$		5.4		nC
Gate-Source Charge	Q_{gs}			0.65		
Gate-Drain Charge	Q_{gd}			1.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 10V, R_G = 6\Omega$ $I_D = 1A, V_{GS} = 4.5V$ $RL = 5.5\Omega$		12		ns
Turn-On Rise Time	t_r			36		
Turn-Off Delay Time	$t_{d(off)}$			34		
Turn-Off Fall Time	t_f			10		
Input Capacitance	C_{iss}	$V_{DS} = 10V, V_{GS} = 0V$ $f = 1.0$ MHz		340		pF
Output Capacitance	C_{oss}			115		
Reverse Transfer Capacitance	C_{rss}			33		
Source-Drain Diode						
Max. Diode Forward Current	I_S				1.6	A
Diode Forward Voltage	V_{SD}	$I_S = 1.0A, V_{GS} = 0V$			1.0	V

Notes

- ³⁾ Short duration test pulse used to minimize self-heating effect.
- ⁴⁾ Pulse test pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.



SOT-23 PACKAGE OUTLINE Plastic surface mounted package



SOT-23	
A	2.90 ± 0.10
B	1.30 ± 0.10
C	1.00 ± 0.10
D	0.40 ± 0.10
E	2.40 ± 0.20
G	1.90 ± 0.10
H	0.95 ± 0.05
J	0.13 ± 0.05
K	0.00-0.10
M	≥ 0.2
N	0.60 ± 0.10
P	7 ± 2°

(UNIT): mm

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